THE UNIVERSITY OF WISCONSIN-MILWAUKEE College of Engineering and Applied Science

FACULTY MEETING

Friday, November 20, 2015

AGENDA

The November 20, 2015 faculty meeting has been canceled due to a lack of business.

AUTOMATIC CONSENT BUSINESS

A. New Courses and Course Changes – See Attachment 1

NOTE TO FACULTY:

CEAS Faculty legislation allows for the approval of Automatic Consent Business in the absence of a regularly scheduled faculty meeting. If there is any objection to the above, consideration will be delayed until the next regularly scheduled faculty meeting.

Objections to approval of the above must be received by the Secretary of the CEAS Faculty in writing before 1:30 p.m., Friday, November 20, 2015.

John R. Reisel, Secretary CEAS Faculty

JRR Attachments

ATTACHMENT 1

NEW COURSES

BME 690	TOPICS IN BIOMEDICAL ENGINEERING, 3 cr., U/G Specific topics, credits, and any additional prerequites will be announced in the Schedule of Classes each time the course is offered. May be taken with change in topic to max of 9 cr. Prereq: jr st.
BME 733	SENSORS AND SYSTEMS, 3 cr., G Physical principles and working of sensors, interfacing, and sensor networks.; Jointly offered with & counts as repeat of ElecEng 733 & MechEng 733. Prereq: grad st; ElecEng 305 or cons. instr.
ELECENG 733	SENSORS AND SYSTEMS, 3 cr., G Physical principles and working of sensors, interfacing, and sensor networks.; Jointly offered with & counts as repeat of BME 733 & MechEng 733. Prereq: grad st; ElecEng 305 or cons. instr.
MECHENG 733	SENSORS AND SYSTEMS, 3 cr., G Physical principles and working of sensors, interfacing, and sensor networks.; Jointly offered with & counts as repeat of BME 733 & ElecEng 733. Prereq: grad st; ElecEng 305 or cons. instr.
CIV ENG 555	SUSTAINABLE CONSTRUCTION MATERIALS AND TECHNIQUES, 3 cr., U/G Sustainable construction materials and methodologies related to commercial construction, LEED/Green certifications, material selection. Prereq: none
COMPSTD 701	MATHEMATICAL AND COMPUTING FUNDAMENTALS FOR IT PROFESSIONALS, 3 cr., G Introductory discussion of logic and reasoning techniques, discrete structures, combinatorics, probability, and their applications to IT Two 75 minute meetings per week
MECHENG 706	CONTINUUM MECHANICS, 3 cr., G Basic concepts of the continuum models used in the various fields of mechanics including fluid mechanics, rheology, elasticity, fracture mechanics and plasticity. Prereq. Graduate Standing

COURSE CHANGES

COMPSCI 747 PRINCIPLES AND PRACTICES OF USER INTERFACE DESIGNI, 3 cr., G Principles and practices of user interface design for desktop, web, and mobile applications: interaction principles; UI design elements; user-centered design process and practices. Prereq: grad st.

had been COMPSCI 747 HUMAN-COMPUTER INTERACTION, 3 cr., G Survey of principles, practice, and current research in human-computer interaction including hci theories, design processes, assessment techniques, and tools. Prereq: grad st. COMPSCI 738 PROGRAM ANALYSIS FOR SOFTWARE ENGINEERING, 3 cr., G Static techniques for determining run-time properties of a program: data-flow analysis, abstract interpretation. Prereq: grad st. had been COMPSCI 838 PROGRAM ANALYSIS, 3 cr., G Static techniques for determining run-time properties of a program: data-flow analysis, abstract interpretation. Prereq: grad st; CompSci 754(P) or 732(P) or equiv or cons instr. COMPSCI 995 MASTER'S CAPSTONE PROJECT, 1-3 cr., G Independent project supervised by student's adviser. Prereq: grad st; cons instr & grad prog comm. had been COMPSCI 995 MASTER'S CAPSTONE PROJECT, 3 cr., G Independent project supervised by student's adviser. Prereq: grad st; cons instr & grad prog comm. MATLENG 511 ADVANCED MATERIALS CHARACTERIZATION, 3 cr., U/G Theory and operation of advanced materials characterization instrumentation including thermal analysis (TGA, DSC, DMA), XRD, SEM/EDS, FTIR/Raman, 3D confocal microscopy; Prereq: MatlEng 411 had been MATLENG 511 ADVANCED MATERIALS CHARACTERIZATION, 3 cr., U/G Theory and operation of advanced materials characterization instrumentation including thermal analysis, XRD, FT-IR, Raman, AFM, and nanoindenter. Prereq: None